

### SMD ■High Power LED 67-21S/NG3C-D2035N3PB2936Z15/2T



#### Features

- PLCC-2 package
- Top view Green LED
- Wide viewing angle
- Pb-free
- RoHS compliant

#### Description

The Everlight 67-21S package has high efficacy, High power consumption, wide viewing angle and a compact form factor. These features make this package an ideal LED for all lighting applications.

#### Applications

- Decorative and Entertainment Lighting
- Agriculture Lighting
- General use

## Device Selection Guide

| Chip Materials | Emitted Color | Resin Color |
|----------------|---------------|-------------|
| InGaN          | Green         | Water Clear |

## Absolute Maximum Ratings (T<sub>Soldering</sub>=25°C)

| Parameter                                       | Symbol              | Rating  | Unit |
|---|---------------------|---|------|
| Forward Current                                 | I <sub>F</sub>      | 150   | mA   |
| Peak Forward Current (Duty 1/10 @10ms)          | I <sub>FP</sub>     | 300   | mA   |
| Power Dissipation                               | P <sub>d</sub>      | 435   | mW   |
| Operating Temperature                           | T <sub>opr</sub>    | -40 ~ +85   | °C   |
| Storage Temperature                             | T <sub>stg</sub>    | -40 ~ +100  | °C   |
| Thermal Resistance (Junction / Soldering point) | R <sub>th J-S</sub> | 50  | °C/W |
| Junction Temperature                            | T <sub>j</sub>      | 115   | °C   |
| Soldering Temperature                           | T <sub>sol</sub>    | Reflow Soldering : 260 °C for 10 sec.<br>Hand Soldering : 350 °C for 3 sec. |      |

Note:

- 1.The products are sensitive to static electricity and must be carefully taken when handling products
2. Test result of Electrostatic Discharge is only for reference.

## Electro-Optical Characteristics (T<sub>Soldering</sub>=25°C)

| Parameter          | Symbol            | Min.  | Typ.  | Max.  | Unit | Condition             |
|--------------------|-------------------|-------|-------|-------|------|-----------------------|
| Luminous flux (1)  | ∅                 | 25    | ----- | 45    | lm   | I <sub>F</sub> =150mA |
| Forward Voltage(2) | V <sub>F</sub>    | 2.9   | ----- | 3.6   | V    | I <sub>F</sub> =150mA |
| Viewing Angle      | 2θ <sub>1/2</sub> | ----- | 120   | ----- | deg  | I <sub>F</sub> =150mA |
| Reverse Current    | I <sub>R</sub>    | ----- | ----- | 50    | μA   | V <sub>R</sub> =5V    |

Notes:

1. Tolerance of Radiometric Luminous flux: ±11%.
2. Tolerance of Forward Voltage: ±0.1V.

### Bin Range of Photometric

| Bin Code | Min. | Max. | Unit | Condition             |
|----------|------|------|------|-----------------------|
| N3       | 24   | 27   | lm   | I <sub>F</sub> =150mA |
| N4       | 27   | 33   |      |                       |
| P0       | 33   | 36   |      |                       |
| PA       | 36   | 40   |      |                       |
| PB       | 40   | 45   |      |                       |

Notes:  
 Tolerance of Luminous flux: ±11%

### Bin Range of Forward Voltage

| Bin Code | Min. | Max. | Unit | Condition             |
|----------|------|------|------|-----------------------|
| 36       | 2.9  | 3.0  | V    | I <sub>F</sub> =150mA |
| 37       | 3.0  | 3.1  |      |                       |
| 38       | 3.1  | 3.2  |      |                       |
| 39       | 3.2  | 3.3  |      |                       |
| 40       | 3.3  | 3.4  |      |                       |
| 41       | 3.4  | 3.5  |      |                       |
| 42       | 3.5  | 3.6  |      |                       |

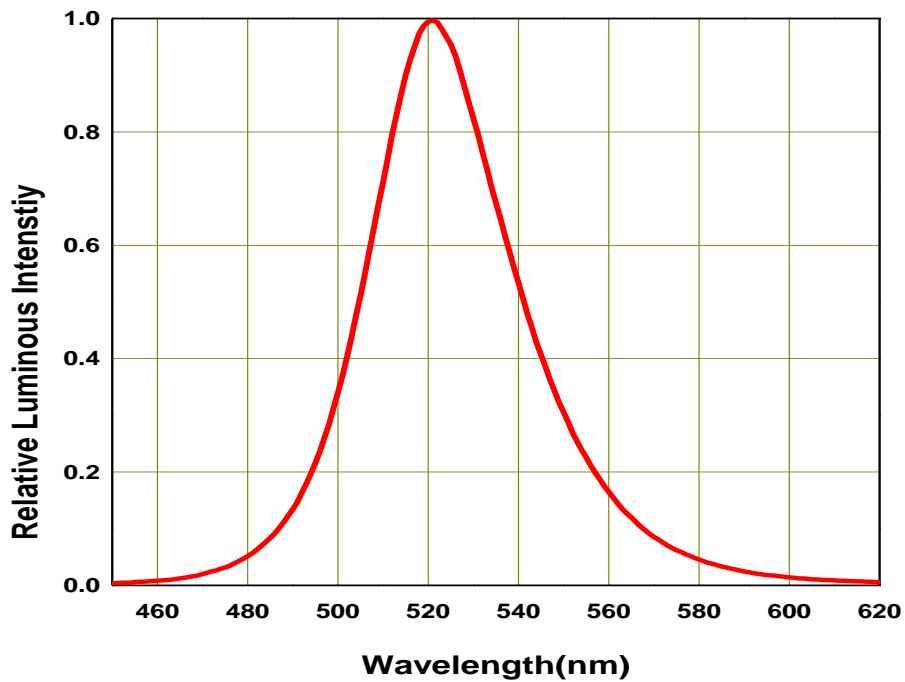
Note:  
 Tolerance of Forward Voltage: ±0.1V.

### Dominant Wavelength Bins

| Bin Code | Min. | Max. | Unit | Condition             |
|----------|------|------|------|-----------------------|
| G52      | 520  | 525  | nm   | I <sub>F</sub> =150mA |
| G53      | 525  | 530  |      |                       |
| G54      | 530  | 535  |      |                       |

Notes:  
 Dominant / Peak wavelength measurement tolerance: ±1nm.

## Spectrum Distribution



## Typical Electro-Optical Characteristics Curves

Fig.1 – Forward Voltage Shift vs. Junction Temperature

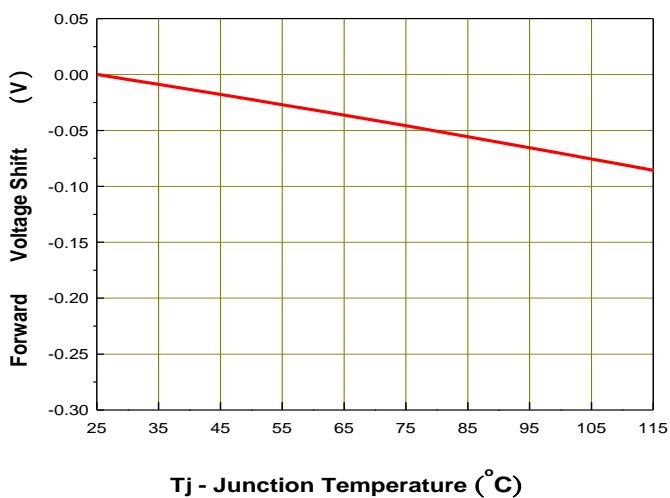
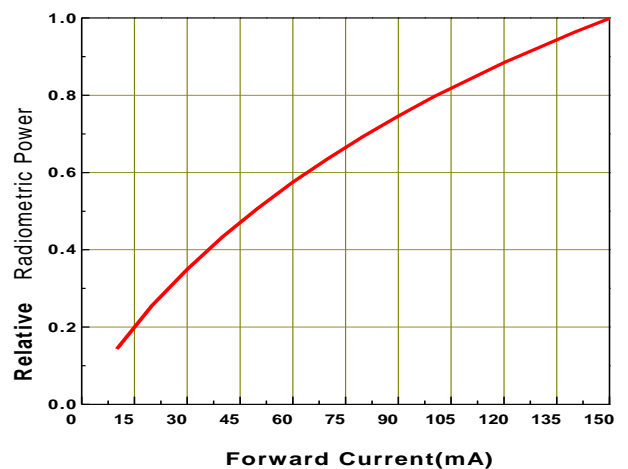


Fig.2 - Relative Radiometric Power vs. Forward Current



Typical Electro-Optical Characteristics Curves

Fig.3 - Relative Luminous Intensity vs. Junction Temperature

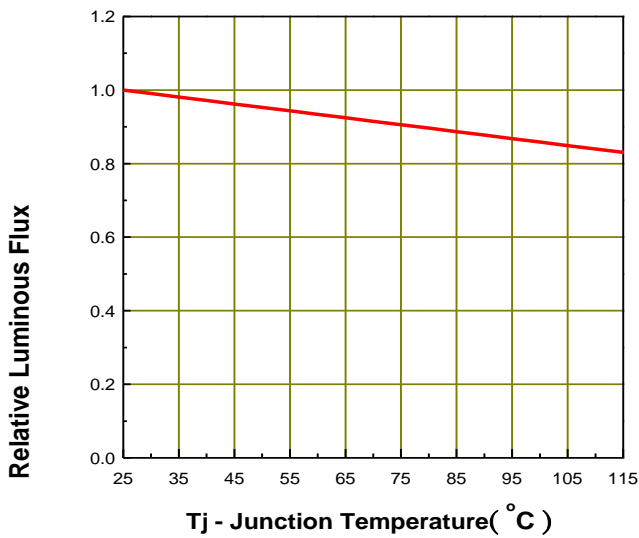


Fig.4 - Forward Current vs. Forward Voltage

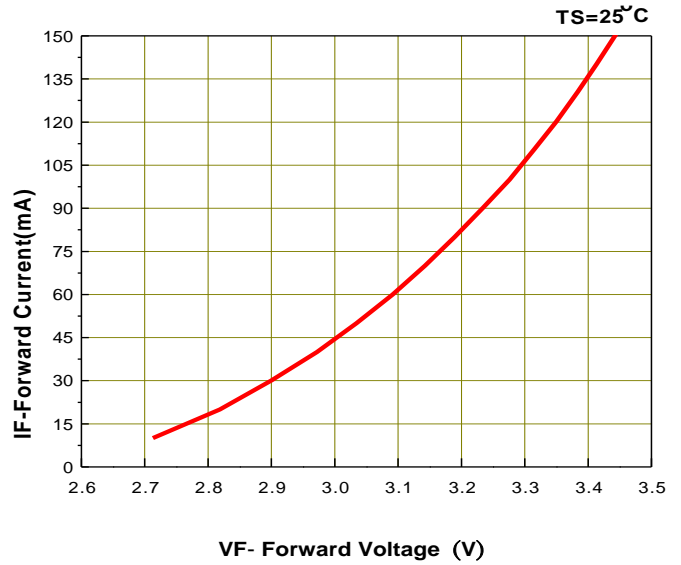


Fig.5 - Max. Driving Forward Current vs. Soldering Temperature

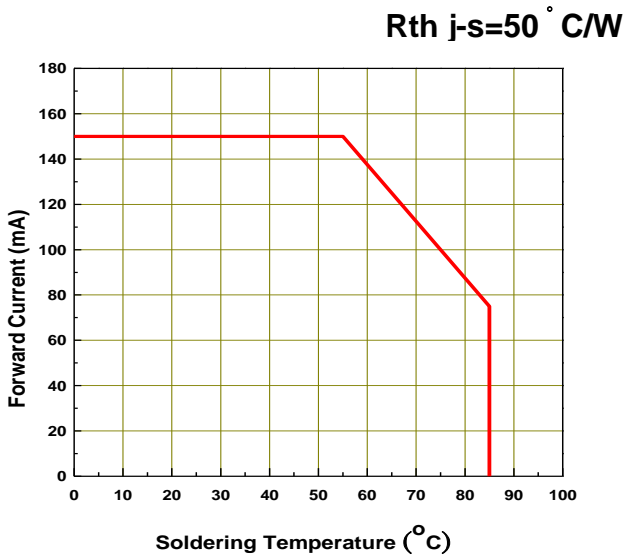
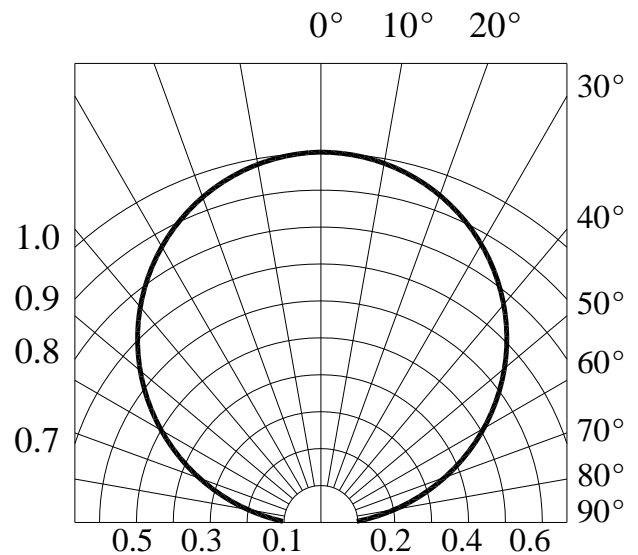
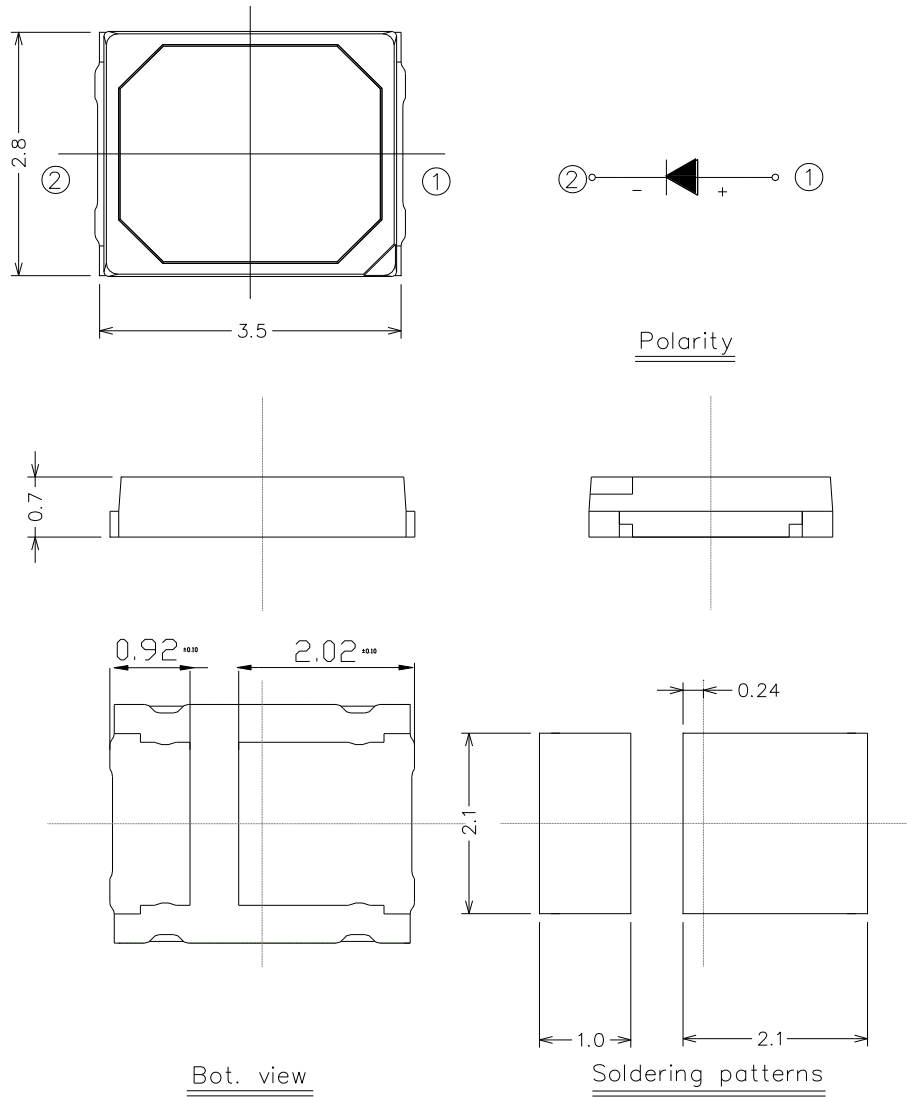


Fig.6 - Radiation Diagram



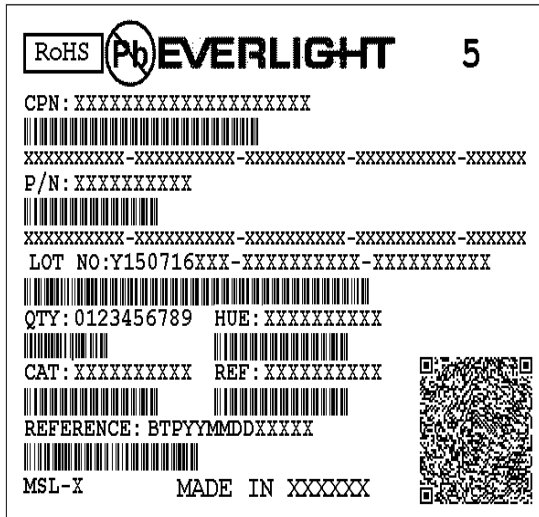
## Package Dimension



Note:  
Tolerance unless mentioned is  $\pm 0.15$  mm; Unit = mm

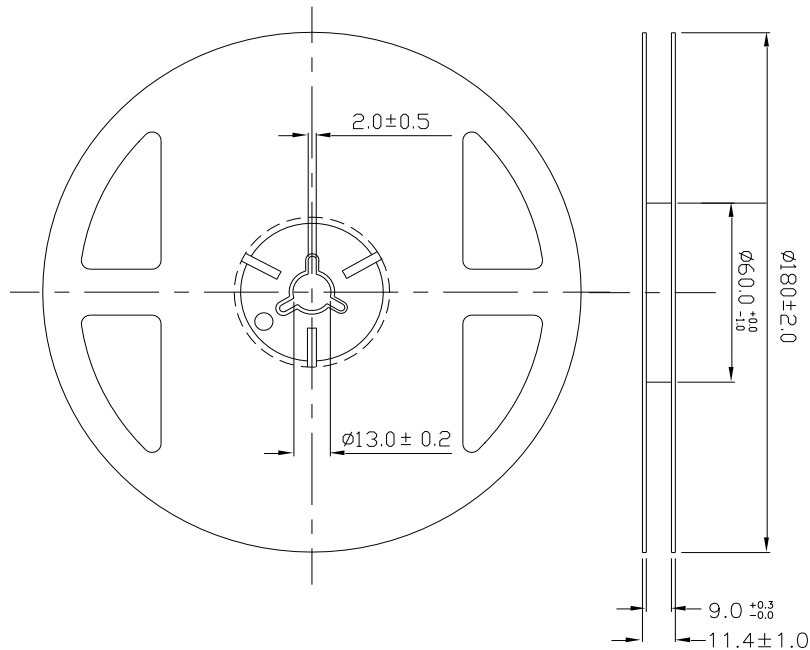
**Moisture Resistant Packing Materials**

**Label Explanation**



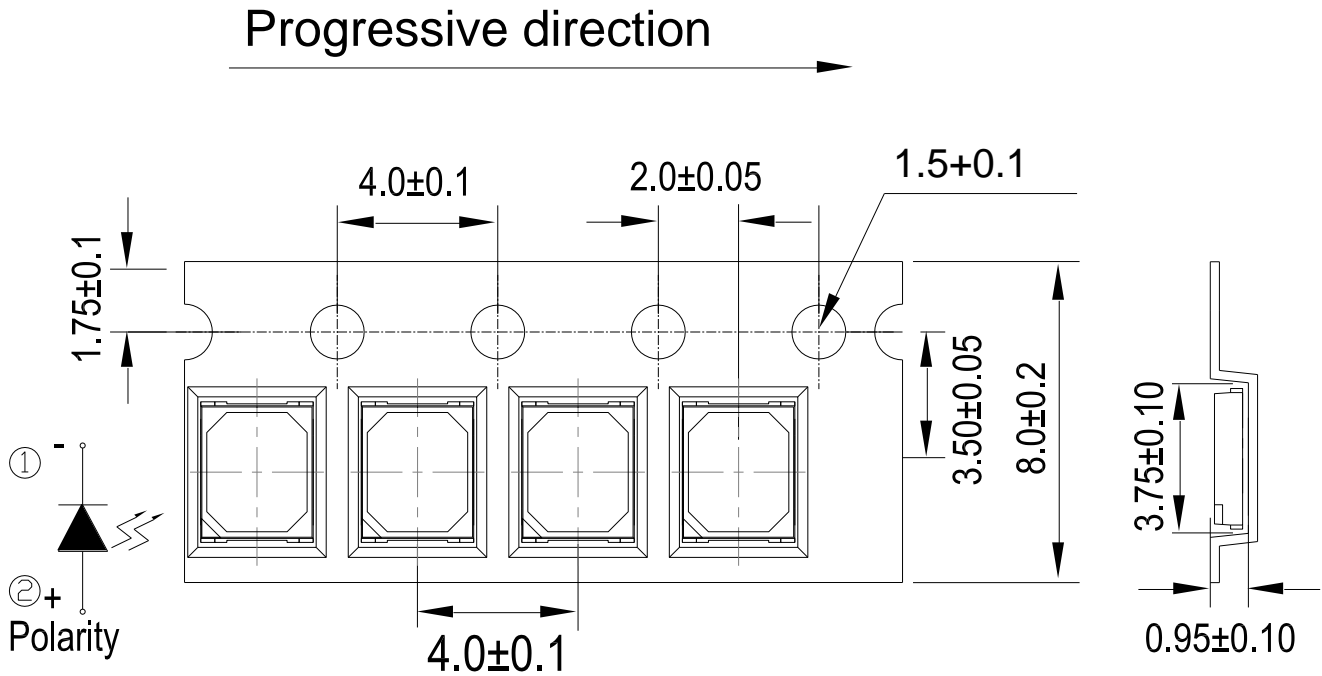
- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

**Reel Dimensions**



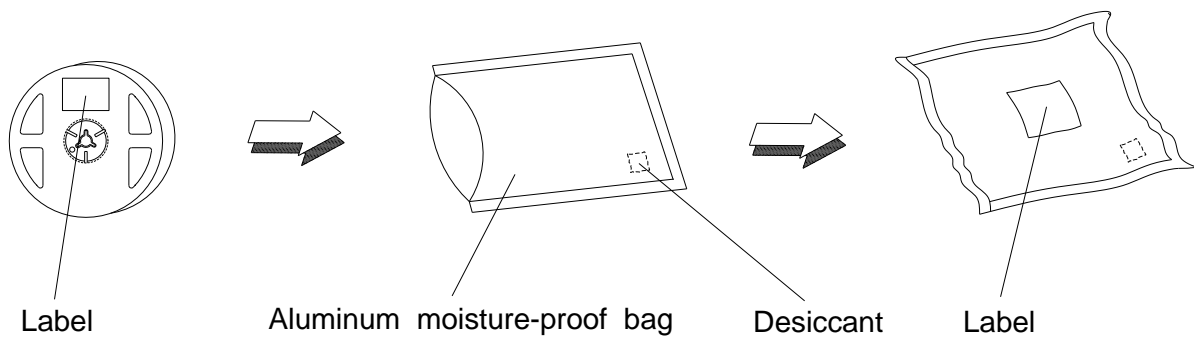
Note:  
 Tolerances unless mentioned  $\pm 0.1$  mm. Unit = mm

Carrier Tape Dimensions: Loaded Quantity 4000 pcs. Per Reel



Note:  
Tolerance unless mentioned is  $\pm 0.1$ mm; Unit = mm

### Moisture Resistant Packing Process





## Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

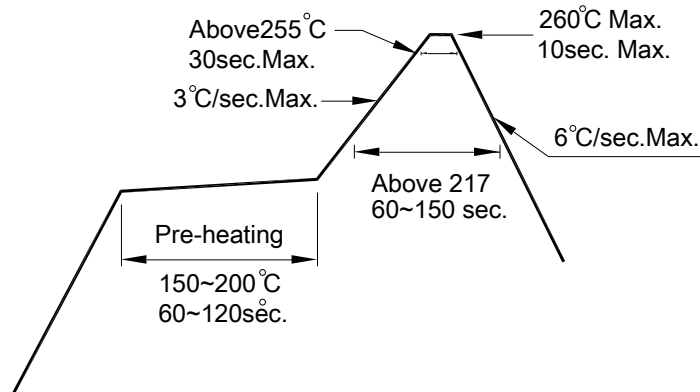
Confidence level : 90%

LTPD : 10%

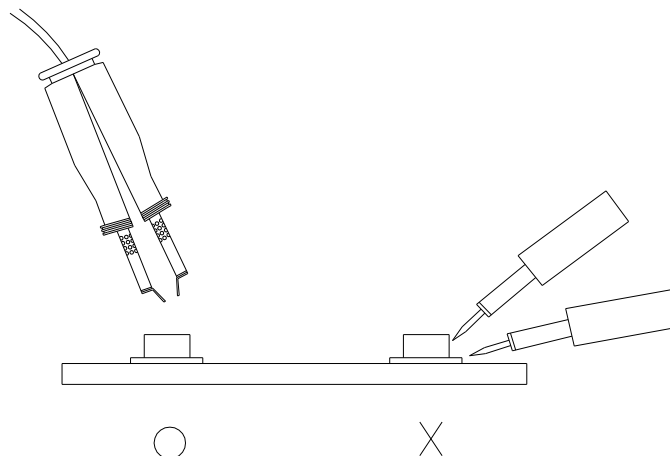
| No. | Items                               | Test Condition                                  | Test Hours/Cycles | Sample Size | Ac/Re |
|-----|-------------------------------------|---|-------------------|-------------|-------|
| 1   | Reflow Soldering                    | Temp. : 260°C/10sec.                            | 6 Min.            | 22 PCS.     | 0/1   |
| 2   | Thermal Shock                       | H : +100°C 20min<br>∫ 10 sec<br>L : -10°C 20min | 200 Cycles        | 22 PCS.     | 0/1   |
| 3   | Temperature Cycle                   | H : +100°C 30min<br>∫ 5 min<br>L : -40°C 30min  | 200 Cycles        | 22 PCS.     | 0/1   |
| 4   | High Temperature/Humidity Storage   | Ta=85°C,85%RH                                   | 1000 Hrs.         | 22 PCS.     | 0/1   |
| 5   | High Temperature/Humidity Operation | Ta=85°C,85%RH,<br>If = 75mA                     | 1000 Hrs.         | 22 PCS.     | 0/1   |
| 6   | Low Temperature Storage             | Ta=-40°C  | 1000 Hrs.         | 22 PCS.     | 0/1   |
| 7   | High Temperature Storage            | Ta=85°C   | 1000 Hrs.         | 22 PCS.     | 0/1   |
| 8   | Low Temperature Operation Life      | Ta=-40°C,<br>If = 150 mA                        | 1000 Hrs.         | 22 PCS.     | 0/1   |
| 9   | High Temperature Operation/ Life#1  | Ta=25°C,<br>If = 150 mA                         | 1000 Hrs.         | 22 PCS.     | 0/1   |
| 10  | High Temperature Operation/ Life#2  | Ta=55°C,<br>If =150mA                           | 1000 Hrs.         | 22 PCS.     | 0/1   |
| 11  | High Temperature Operation/ Life#3  | Ta=85°C,<br>If = 75 mA                          | 1000 Hrs.         | 22 PCS.     | 0/1   |

## Precautions for Use

1. Over-current-proof  
Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).
2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
  - 2.3 After opening the package: The LED's floor life is 168 Hrs under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
  - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.  
Baking treatment: 60±5°C for 24 hours.
3. Soldering Condition
  - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
4. Soldering Iron  
Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.
5. Repairing  
Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



## **DISCLAIMER**

1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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6. This product is not intended to be used for military, aircraft, automotive, medical,

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